

# Model 406 Single Element Pyroelectric IR Detector With Source Follower

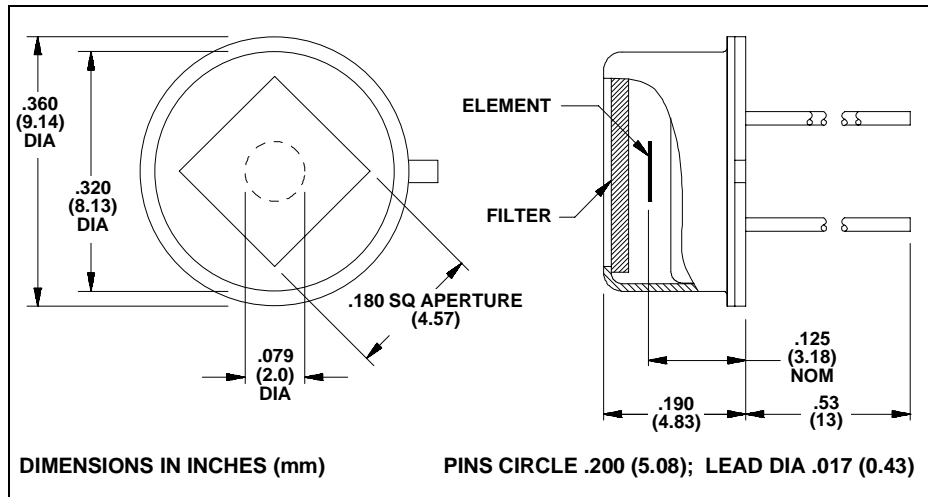


Manufactured under one or more of the following U.S. patents: 3,839,640 - 4,218,620 - 4,326,663 - 4,384,207 - 4,437,003 - 4,441,023 - 4,523,095

**Model 406** contains a single lithium tantalate sensing element and a JFET source follower sealed into a standard TO-5 transistor package with an optical filter.

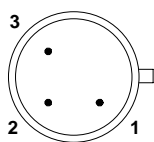
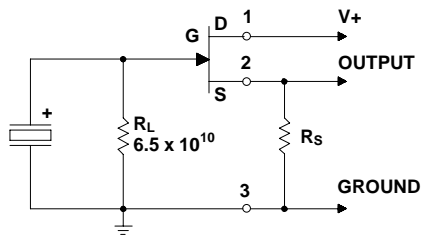
A patented element mounting technique is used to improve thermal time constant and reduce effects of microphony.

A source resistor is needed to set the drain current and consequently the operating parameters of the JFET. A 47kΩ or greater value resistor is recommended.



## Applications

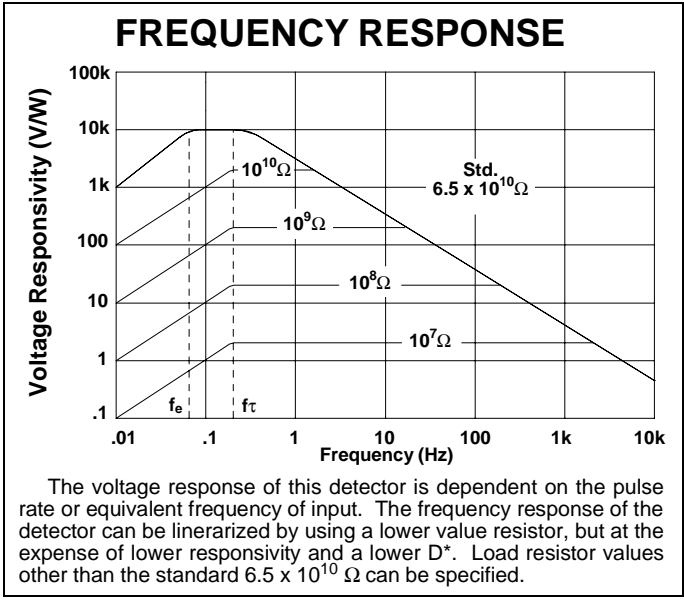
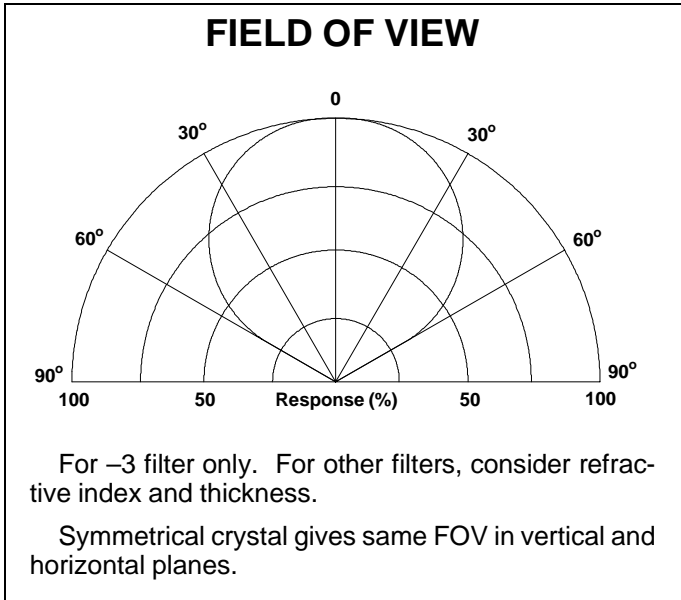
- Motion Sensing
- Lighting Control
- Intrusion Detection
- Industrial Control
- Gas Analysis
- Heating/AC Control
- Pyrometry
- Low-power Laser Detection
- Robotics
- Instrumentation



**PIN DESIGNATIONS**  
 1. V+  
 2. OUTPUT  
 3. GND/CASE

Characteristics	406	Unit	Test Conditions	ELTECdata Reference
Detector Type	Single			
Element Size	2.0	mm, Dia		
Optical Bandwidth	0.1 to 1,000	$\mu\text{m}$	Various Filters	101
Responsivity (min)	2100	V/W	8 to 14 $\mu\text{m}$ , 1Hz	
Responsivity (typ)	2350			
Noise (typ)	2.0	$\mu\text{Vrms}/\sqrt{\text{Hz}}$	1Hz	
Noise (max)	4.3			
NEP (typ)	$8.5 \times 10^{-10}$	$\text{W}/\sqrt{\text{Hz}}$	8 to 14 $\mu\text{m}$ , 1Hz, 1Hz BW	100
NEP (max)	$2.0 \times 10^{-9}$			
$D^*$ (min)	$0.9 \times 10^8$	$\text{cm}\sqrt{\text{Hz}}/\text{W}$	8 to 14 $\mu\text{m}$ , 1Hz, 1Hz BW	100
$D^*$ (typ)	$2.1 \times 10^8$			
Operating Voltage (min)	3	VDC	V+ to Gnd	104 (4.1.c)
Operating Voltage (max)	15			
Operating Current (min)	3	$\mu\text{A}$	$R_S=100\text{k}\Omega$	104 (4.1.c)
Operating Current (max)	12			
Offset Voltage (min)	0.3	V	$R_S=100\text{k}\Omega$	106 Section B
Offset Voltage (max)	1.2			
Output Impedance	$<R_S$	$\Omega$		
Thermal Breakpoint $f_T$ (typ)	0.25	Hz		102
Electrical Breakpoint $f_e$ (typ)	0.08	Hz	$R_L=6.5 \times 10^{10}\Omega$	102
Recommended Operating Temperature	-10 to +50	$^{\circ}\text{C}$	Functional	
Storage Temperature	-55 to +125	$^{\circ}\text{C}$	$\Delta T < 50^{\circ}\text{C}/\text{min}$	
Output Protection	Do not exceed a maximum drain current of 50 $\mu\text{A}$			

Characteristics at 25°C, with -3 filter, V+= 5 VDC,  $R_S=100\text{k}\Omega$  unless otherwise stated. Data is established on a sample basis and is believed to be representative.

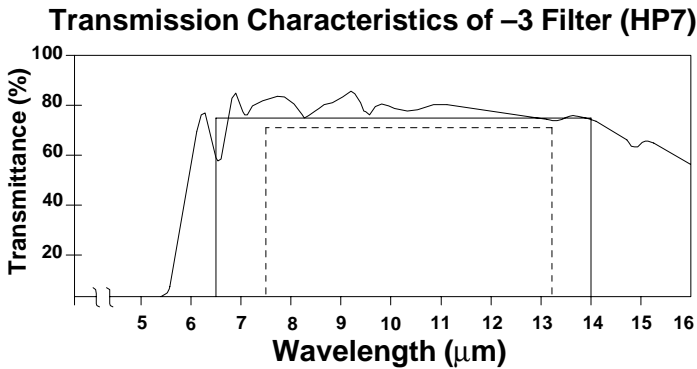


For best results, the following precautions and recommendations should be observed. (See ELTECdata #101):

**Mounting:** Avoid mechanical stresses on case and leads.

**Soldering:** Detectors must be hand soldered to minimize the chance of destroying the internal components. Avoid machine or hot air soldering. Leave a minimum lead length of .250 inch (6.35mm). When soldering to detector leads, use a heat sink between the case and leads. Beware that the new RoHS compliant solders require a higher soldering temperature making heat sinking the detector extremely important.

**Static Discharge:** Protect detectors from electro-static charges.



75% Transmission Average      70% Transmission Absolute

Transmission below cutoff is  $<1\%$

For information on other standard filters available, refer to ELTECdata #101.

**Thermal Shock:** Temperature changes and rate of change must be kept to a minimum ( $<50\text{C}^{\circ}/\text{min.}$ ) to prevent damage.

**Noise:** As a resolution or lower information limit, noise is established not only by the detector. Other noise sources are:

- Radiated and conducted RF signals
- Subsequent amplification or signal conditioning stages
- Power supply noise
- Components, such as high value resistors and capacitors (tantalum and aluminum electrolytic)
- Mechanical contacts and weak solder joints
- Shock and vibration excited microphonics
- Outside thermal influences on the detector other than the desired infrared input, i.e. drafts

All of these noise sources should be considered carefully when the information signal is  $<1\text{mV}$ .

**Light Leakage:** Slight sensitivity to visible light leaking through the glass-to-metal seal on the base may be observed.

**Optical Design:** Use of a detector with a filter in an optical system may require consideration of the image displacement toward the filter. This displacement ( $s$ ) caused by the insertion of a planoparallel plate (filter thickness =  $t$ ; refractive index =  $N$ ) is given by  $s = (t/N)(N-1)$ .

**NOTICE:** The information provided herein is believed to be reliable. However, ELTEC Instruments, Inc. assumes no responsibility for inaccuracies or omissions. Due to industry components being incorporated into ELTEC's devices and ELTEC continually striving for product improvement, specifications may change without notice.



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